NCE N-Channel Enhancement Mode Power MOSFET

Description

The NCE01H10 uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

General Features

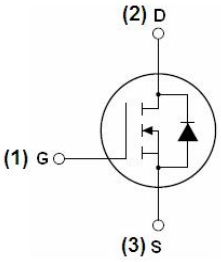
- V_{DS} = 100V,I_D =100A
  $R_{DS(ON)}$ < 12mΩ @ V_{GS}=10V (Typ:9.9mΩ)
- Special process technology for high ESD capability
- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Good stability and uniformity with high E_{AS}
- Excellent package for good heat dissipation

Application

- Power switching application
- Hard switched and high frequency circuits
- Uninterruptible power supply

100% UIS TESTED!

100% ΔVds TESTED!



Schematic diagram

Marking and pin assignment

TO-220-3L top view

Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE01H10	NCE01H10	TO-220-3L	-	-	-

Absolute Maximum Ratings (T_C=25℃unless otherwise noted)

Symbol	Parameter	Limit	Unit
V_{DS}	Drain-Source Voltage	100	V
V_{GS}	Gate-Source Voltage	±20	V
I_D	Drain Current-Continuous	100	A
I_D (100℃)	Drain Current-Continuous(TC=100℃)	80	A
I_{DM}	Pulsed Drain Current	380	A
P_D	Maximum Power Dissipation	200	W
	Derating factor	1.33	W/℃
E_{AS}	Single pulse avalanche energy (Note 5)	720	mJ
T_J,T_{STG}	Operating Junction and Storage Temperature Range	-55 To 175	℃

Thermal Characteristic

$R_{\theta JC}$	Thermal Resistance,Junction-to-Case (Note 2)	0.75	℃/W

Electrical Characteristics (T_C=25℃unless otherwise noted)

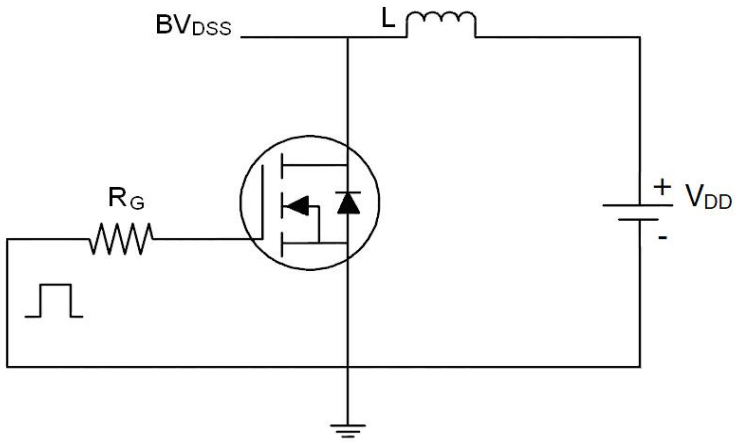
Symbol	Parameter	Condition	Min	Typ	Max	Unit
Off Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	V_{GS}=0V I_D=250μA	100	110	-	V
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS}=100V,V_{GS}=0V	-	-	1	μA
I_{GSS}	Gate-Body Leakage Current	V_{GS}=±20V,V_{DS}=0V	-	-	±100	nA
On Characteristics (Note 3)						
$V_{GS(th)}$	Gate Threshold Voltage	V_{DS}=V_{GS},I_D=250μA	2	3	4	V
$R_{DS(ON)}$	Drain-Source On-State Resistance	V_{GS}=10V, I_D=40A	-	9.9	12	mΩ
g_{FS}	Forward Transconductance	V_{DS}=20V,I_D=40A	-	71	-	S
Dynamic Characteristics (Note4)						
C_{lss}	Input Capacitance	V_{DS}=50V,V_{GS}=0V, F=1.0MHz	-	4820	-	PF
C_{oss}	Output Capacitance		-	244	-	PF
C_{rss}	Reverse Transfer Capacitance		-	197	-	PF
Switching Characteristics (Note 4)						
$t_{d(on)}$	Turn-on Delay Time	V_{DD}=50V,I_D=40A V_{GS}=10V,R_{GEN}=2.5Ω	-	15	-	nS
t_r	Turn-on Rise Time		-	50	-	nS
$t_{d(off)}$	Turn-Off Delay Time		-	40	-	nS
t_f	Turn-Off Fall Time		-	55	-	nS
Q_g	Total Gate Charge	V_{DS}=50V,I_D=40A, V_{GS}=10V	-	123	-	nC
Q_{gs}	Gate-Source Charge		-	27	-	nC
Q_{gd}	Gate-Drain Charge		-	44	-	nC
Drain-Source Diode Characteristics						
V_{SD}	Diode Forward Voltage (Note 3)	V_{GS}=0V,I_S=40A	-	-	1.2	V
I_S	Diode Forward Current (Note 2)	-	-	-	100	A
t_{rr}	Reverse Recovery Time	TJ = 25°C, IF = 40A di/dt = 100A/μs(Note3)	-	38	80	nS
Qrr	Reverse Recovery Charge		-	53	100	nC
t_{on}	Forward Turn-On Time	Intrinsic turn-on time is negligible (turn-on is dominated by LS+LD)				

Notes:

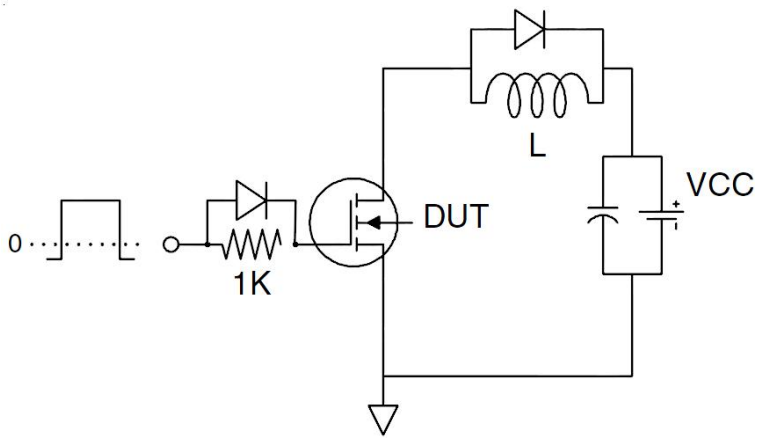
1. Repetitive Rating: Pulse width limited by maximum junction temperature.
2. Surface Mounted on FR4 Board, t ≤ 10 sec.
3. Pulse Test: Pulse Width ≤ 300μs, Duty Cycle ≤ 2%.
4. Guaranteed by design, not subject to production
5. EAS condition:Tj=25℃,V_{DD}=50V,V_G=10V,L=0.5mH,Rg=25Ω

Test Circuit

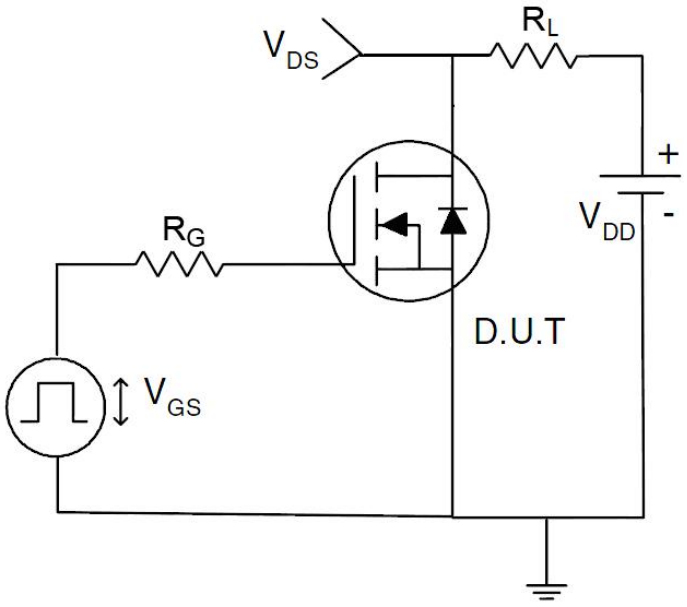
1) E_{AS} test Circuit



2) Gate charge test Circuit



3) Switch Time Test Circuit



Typical Electrical and Thermal Characteristics (Curves)

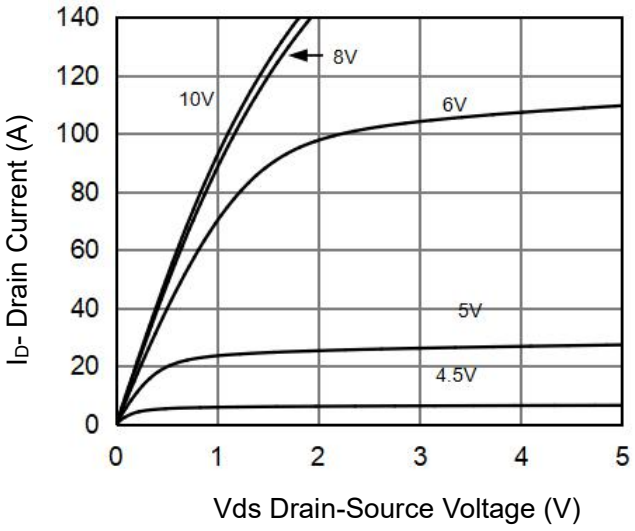


Figure 1 Output Characteristics

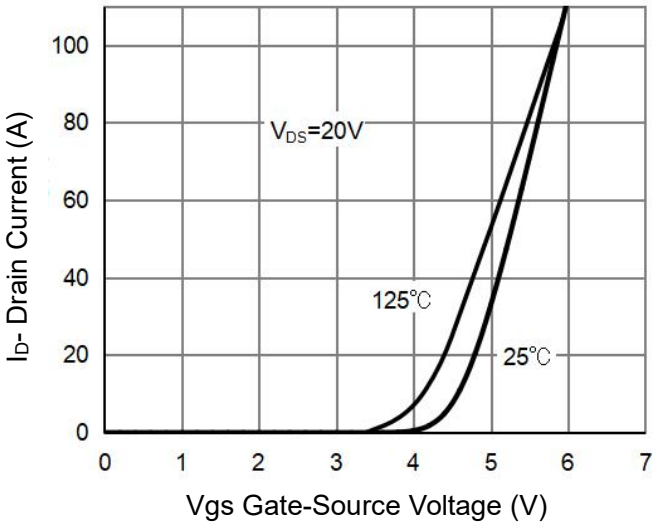


Figure 2 Transfer Characteristics

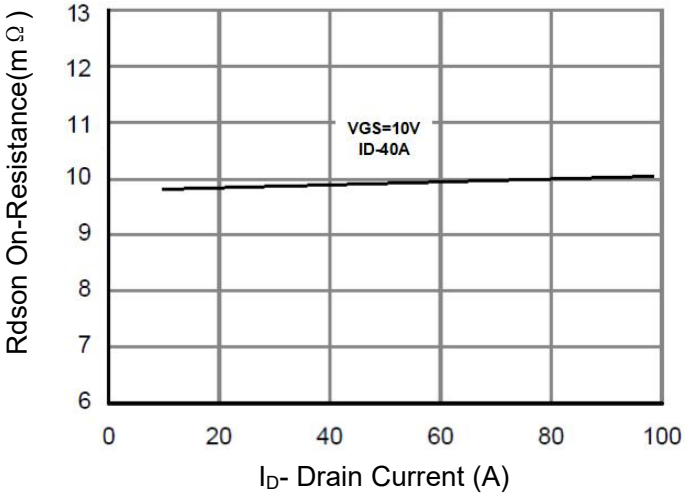


Figure 3 Rdson- Drain Current

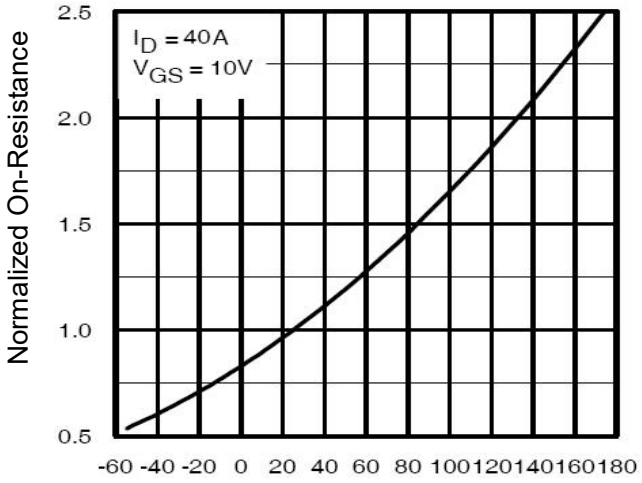


Figure 4 Rdson-JunctionTemperature

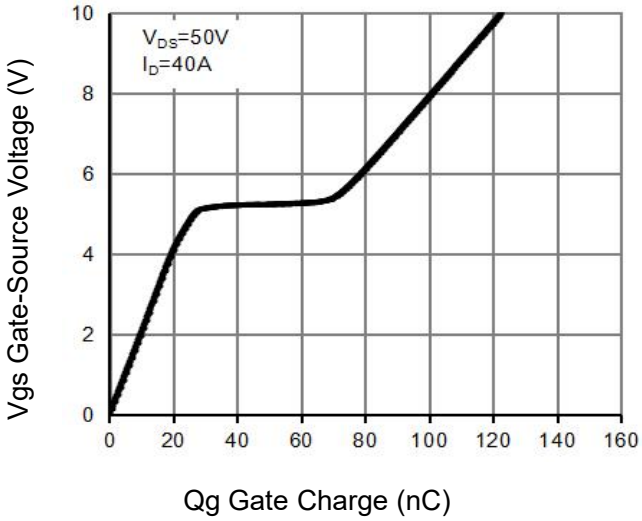


Figure 5 Gate Charge

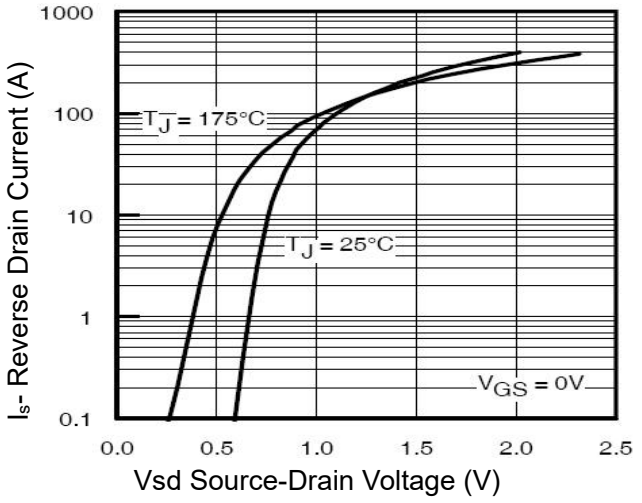


Figure 6 Source- Drain Diode Forward

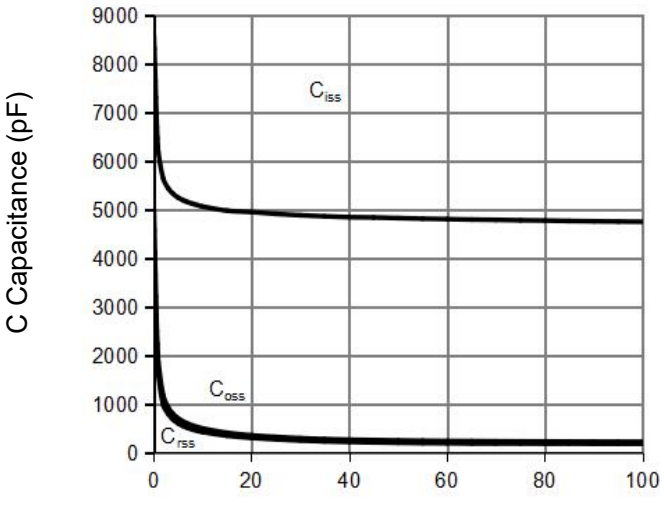


Figure 7 Capacitance vs Vds

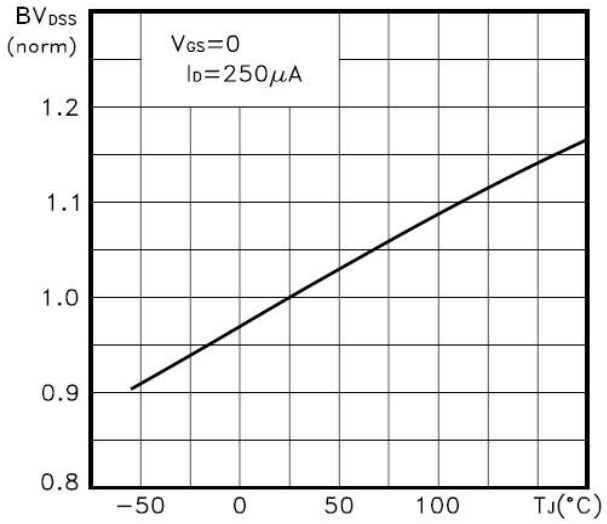


Figure 9 BV_{DSS} vs Junction Temperature

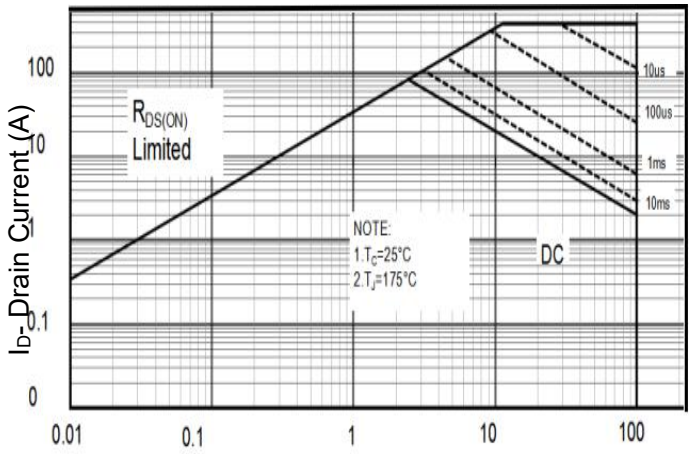


Figure 8 Safe Operation Area

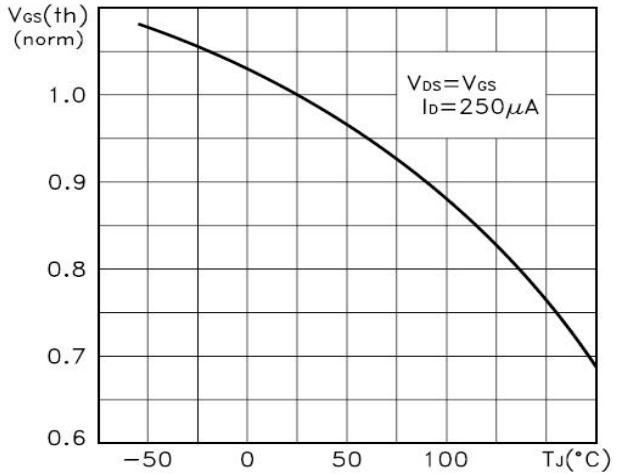


Figure 10 $V_{GS(th)}$ vs Junction Temperature

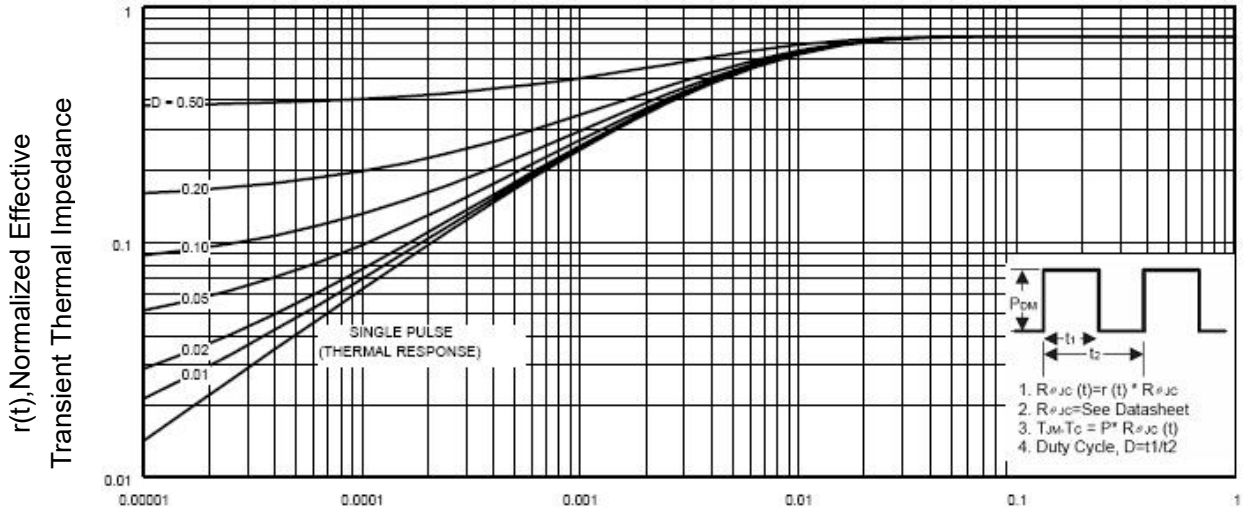
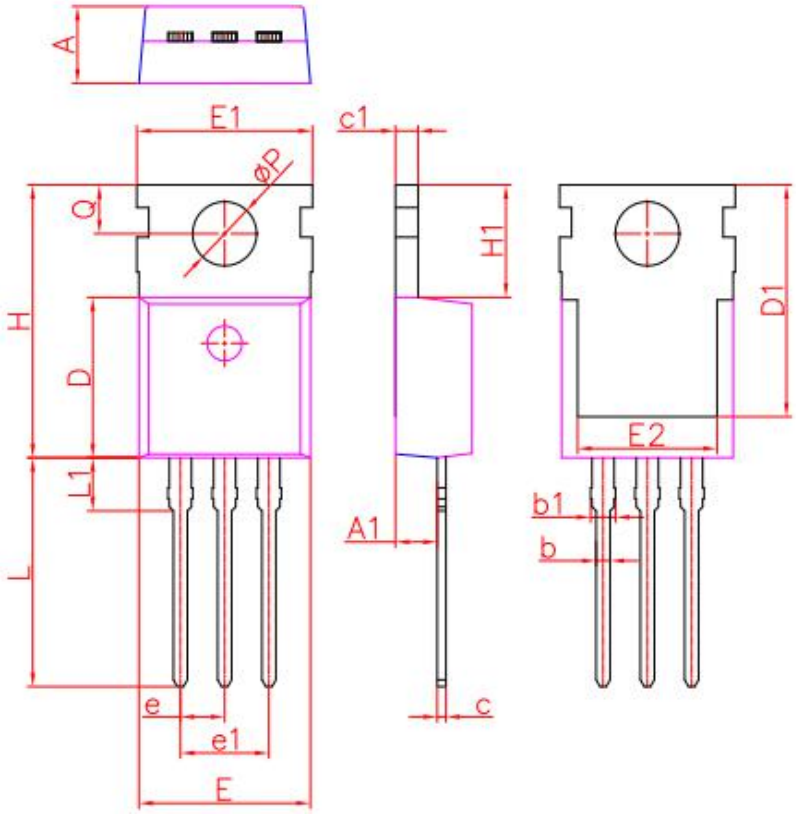


Figure 11 Normalized Maximum Transient Thermal Impedance

TO-220-3L Package Information



TO220			
DIM.	MIN.	NOM.	MAX.
A	4.20	4.40	4.60
A1	2.25	2.40	2.55
b	0.70	0.80	0.90
b1	1.17	1.27	1.37
c	0.33	0.50	0.65
c1	1.20	1.30	1.40
D	8.95	9.20	9.75
D1	13.10	13.30	13.50
E	9.74	9.84	10.04
E1	9.91	10.08	10.25
E2	7.90	8.00	8.10
e	2.54BSC		
e1	5.08BSC		
H	15.45	15.65	15.85
H1	6.30	6.45	6.60
L	12.90	13.13	13.40
L1	2.85	3.05	3.25
Q	2.65	2.80	2.95
øP	3.40	3.68	3.80
All dimensions in millimeters			

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